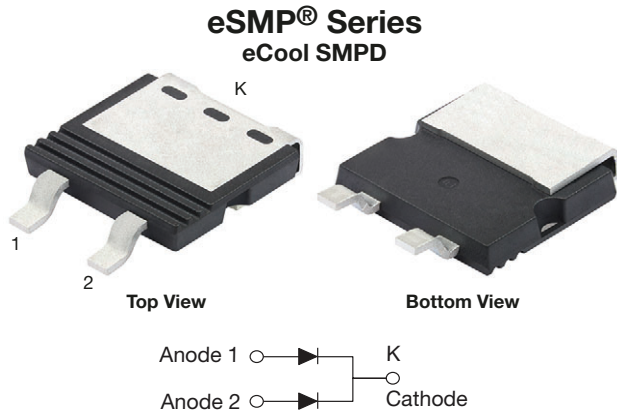


Dual High-Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

 Ultra Low $V_F = 0.51\text{ V}$ at $I_F = 5.0\text{ A}$


LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | |
|--|----------------|
| $I_{F(AV)}$ | 2 x 30 A |
| V_{RRM} | 200 V |
| I_{FSM} | 430 A |
| V_F at $I_F = 30\text{ A}$ ($T_J = 125\text{ °C}$) | 0.70 V |
| T_J max. | 150 °C |
| Package | eCool SMPD |
| Circuit configuration | Common cathode |

FEATURES

- Top side cool
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available:
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

MECHANICAL DATA

Case: eCool SMPD

Molding compound meets UL 94 V-0 flammability rating
 Base P/N-M3 - halogen-free, RoHS-compliant
 Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: as marked

| MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted) | | | |
|--|-------------|-------------------|------|
| PARAMETER | SYMBOL | V60C202C | UNIT |
| Device marking code | | V60C202C | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 200 | V |
| Maximum average forward rectified current (fig. 1) | per device | $I_{F(AV)}^{(1)}$ | A |
| | per diode | $I_{F(AV)}^{(1)}$ | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode | I_{FSM} | 430 | A |
| Operating junction temperature range | $T_J^{(2)}$ | -40 to +150 | °C |
| Storage temperature range | T_{STG} | -55 to +150 | |

Notes

(1) With infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



| ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted) | | | | | | |
|--|------------------------|-------------------------|-------------------------------|-------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage per diode | I _F = 5 A | T _J = 25 °C | V _F ⁽¹⁾ | 0.67 | - | V |
| | I _F = 15 A | | | 0.77 | - | |
| | I _F = 30 A | | | 0.83 | 0.88 | |
| | I _F = 5 A | T _J = 125 °C | | 0.51 | - | |
| | I _F = 15 A | | | 0.62 | - | |
| | I _F = 30 A | | | 0.70 | 0.75 | |
| Reverse current at rated V _R per diode | V _R = 160 V | T _J = 25 °C | I _R ⁽²⁾ | 0.003 | - | mA |
| | | T _J = 125 °C | | 3 | - | |
| | V _R = 200 V | T _J = 25 °C | | - | 0.15 | |
| | | T _J = 125 °C | | 7 | 25 | |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | | C _J | 1300 | - | pF |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: Pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | |
|---|------------------------------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Typical thermal resistance | R _{θJA} ⁽¹⁾⁽²⁾ | 26.5 | 34 | °C/W |
| | R _{θJC} ⁽³⁾ | 0.8 | 1.0 | |

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{θJA}
- (2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz. standard footprint with top-side aluminum cooling heatsink size L 35 mm x W 20 mm x H 10 mm
- (3) Thermal resistance junction-to-top case to follow JEDEC® 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION TABLE

| | | | | | | | | |
|-------------|----------|-----------|----------|-----------|----------|----------|----------|-----------|
| Device code | V | 60 | C | 20 | 2 | C | H | M3 |
| | ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | ⑧ |

- 1** - Vishay TMBS product
- 2** - Current rating (60 = 2 x 30 A)
- 3** - Package type (C = eCool SMPD package)
- 4** - Voltage rating (20 = 200 V)
- 5** - TMBS generation option (2 = Gen 2)
- 6** - Circuit configuration (C = Common cathode)
- 7** - Quality grade (H = AEC-Q101 qualified, otherwise = industry grade)
- 8** - Material / environmental category
(M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free)

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|--------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| V60C202C-M3/I | 0.66 | I | 2000/reel | 13" diameter plastic tape and reel |
| V60C202CHM3/I ⁽¹⁾ | 0.66 | I | 2000/reel | 13" diameter plastic tape and reel |

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

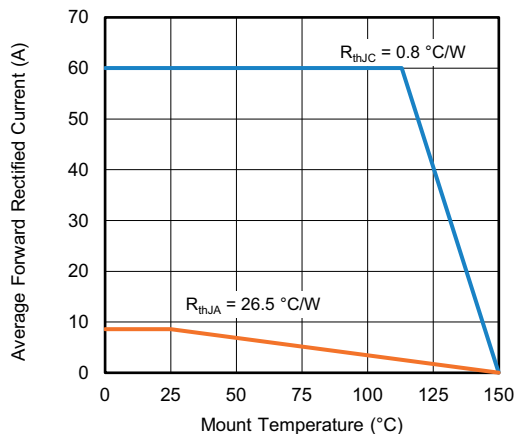


Fig. 1 - Maximum Forward Current Derating Curve

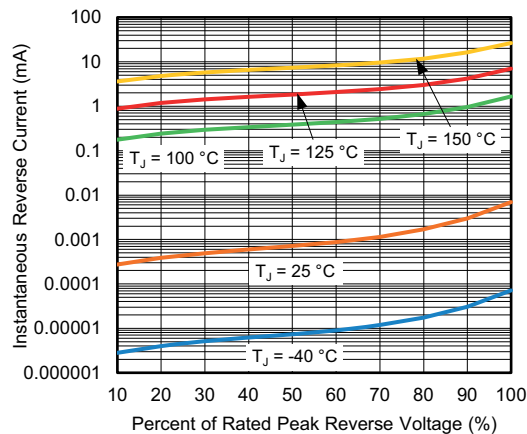


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

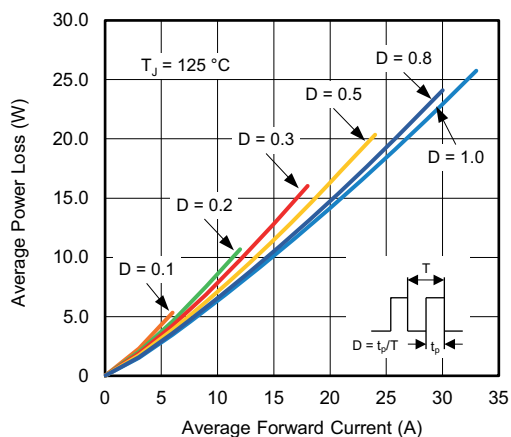


Fig. 2 - Average Power Loss Characteristics Per Diode

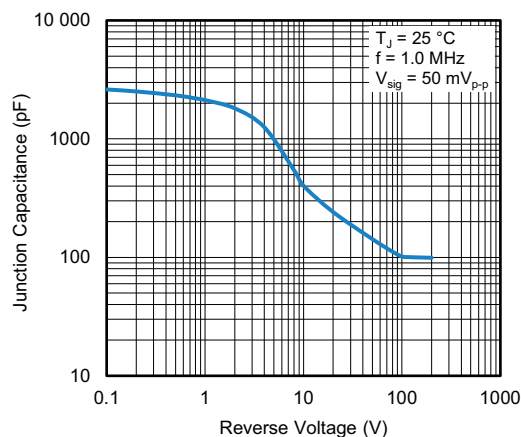


Fig. 5 - Typical Junction Capacitance Per Diode

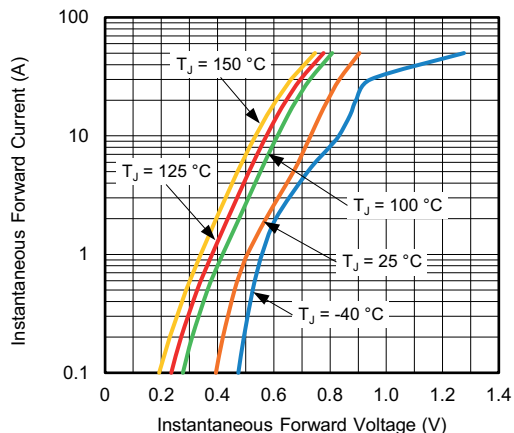


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

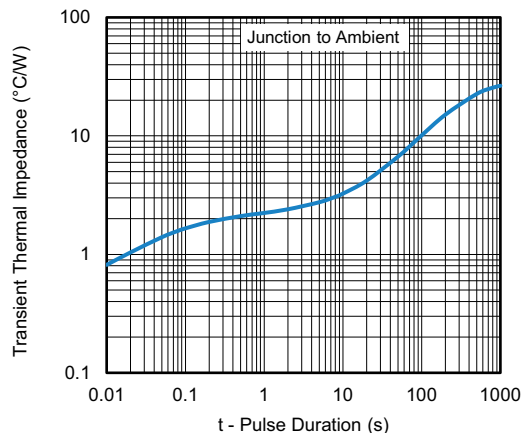
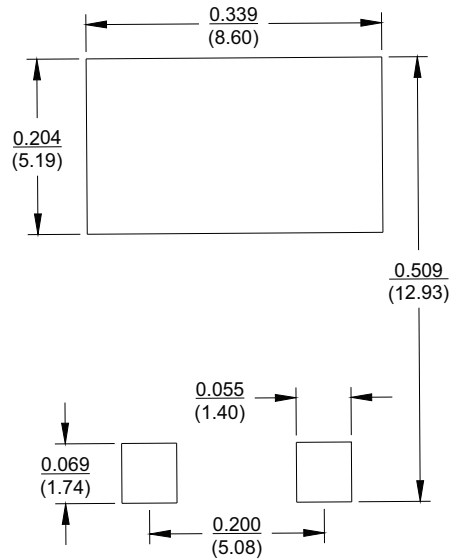
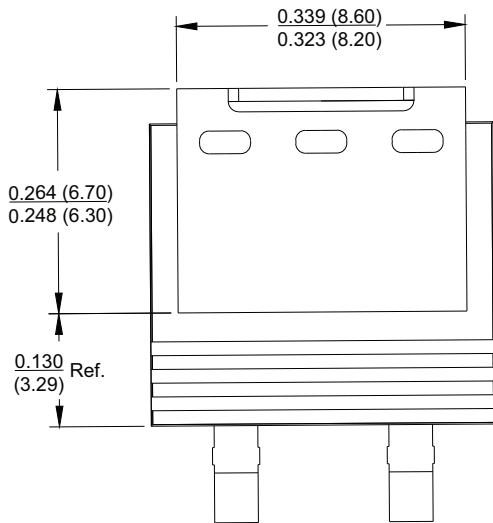
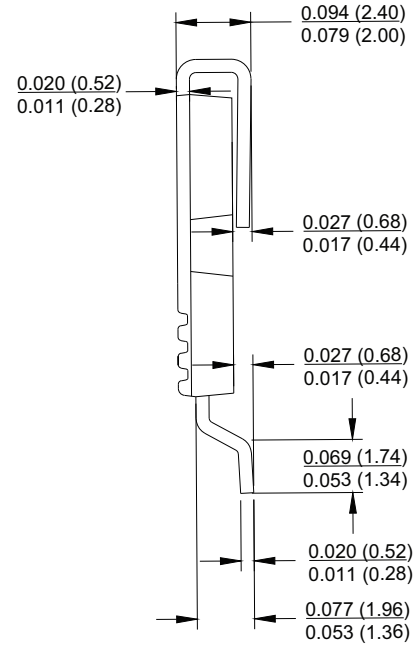
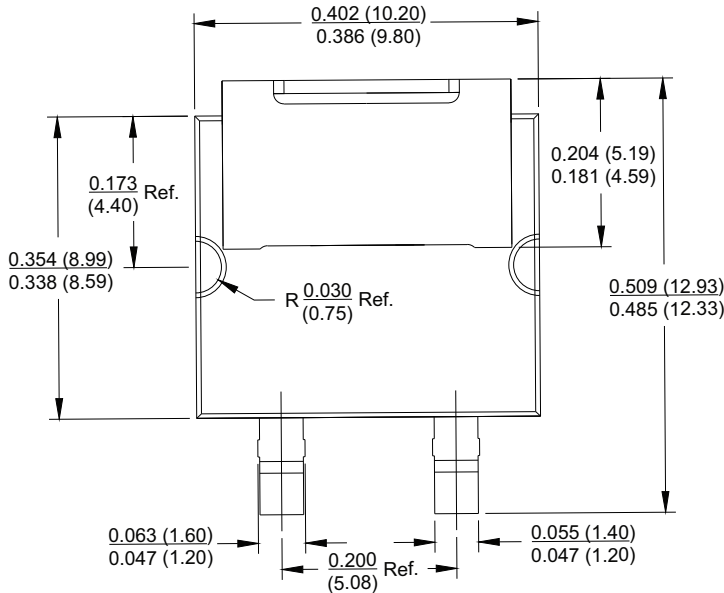


Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

eCool SMPD



Note

- The suggested mounting pad layout is provided for reference only, as actual pad layouts may vary depending on application



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